Date: April 6, 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Hiroshi KITAGAWA, et al.

Serial No.: Not Yet Assigned

(§371 of International Application PCT/JP04/15297)

Filed: **April 6, 2006**

For: AMIDE-BASED COMPOUND, POLYOLEFIN RESIN COMPOSITION AND

MOLDED PRODUCT

PRELIMINARY AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Prior to calculation of the filing fee and examination of this application, please amend the above-identified patent application as follows: